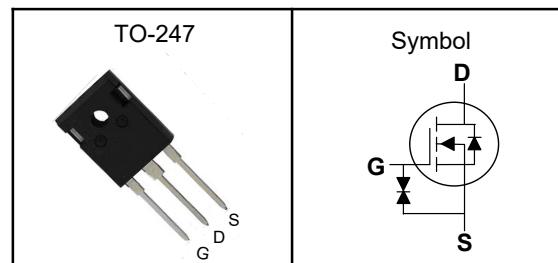


650V Super Junction Power MOSFET

Features

- Low drain-source on-resistance: $R_{DS(ON)}=0.095\Omega$ typ
- Very Low FOM ($R_{DS(ON)} \times Q_g$)
- Extremely low switching loss
- 100% avalanche tested
- RoHS compliant

Pin Description



Applications

- Switch Mode Power Supply (SMPS)
- TV power & LED Lighting Power
- AC to DC Converters
- Telecom

V_{DSS}	650	V
$R_{DS(ON)}$ -Typ	95	$\mu\Omega$
I_D	29.1	A

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	650	V
V_{GSS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
E_{AS}	Single Pulse Avalanche Energy ^③	546	mJ
$I_{DM}^{①}$	300 μs Pulse Drain Current Tested	87	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	29.1
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	205
			W

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ₁ (Max)	62.5	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case ₁	0.61	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

650V Super Junction Power MOSFET

Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=1\text{mA}$	650	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=650\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	uA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=1.29\text{mA}$	2.0	---	4.0	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=11.9\text{A}$	---	95	110	$\text{m}\Omega$
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=400\text{V}$, Freq.=1MHz	---	3300	---	pF
C_{oss}	Output Capacitance		---	69	---	
C_{rss}	Reverse Transfer Capacitance		---	3.7	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=325\text{V}$, $R_G=25\Omega$, $I_D=16.7\text{A}$	---	63	---	nS
T_r	Turn-on Rise Time		---	32	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	280	---	
T_f	Turn-off Fall Time		---	20	---	
Q_g	Total Gate Charge	$V_{\text{DS}}=520\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=16.7\text{A}$	---	75	---	nC
Q_{gs}	Gate-Source Charge		---	14	---	
Q_{gd}	Gate-Drain Charge		---	21	---	
Source-Drain Characteristics ($T_J=25^\circ\text{C}$)						
$V_{\text{SD}}^{④}$	Diode Forward Voltage	$I_S=16.7\text{A}$, $V_{\text{GS}}=0\text{V}$	---	---	1.3	V
t_{rr}	Reverse Recovery Time	$V_R=400\text{V}$, $I_F=16.7\text{A}$, $di/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	455	---	nS
Q_{rr}	Reverse Recovery Charge		---	8.1	---	nC

Note ④ : Pulse test (pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

650V Super Junction Power MOSFET

On Region Characteristics

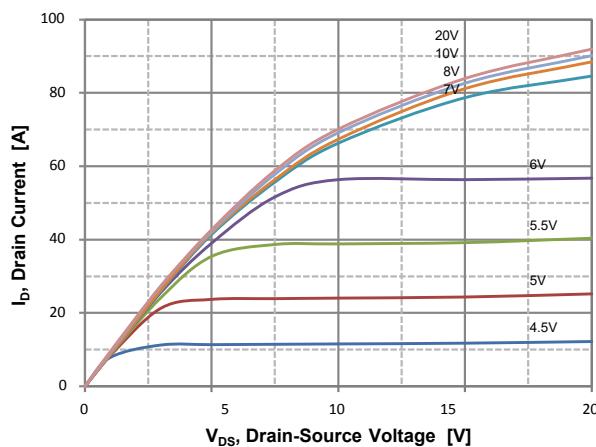


Figure 1. On Region Characteristics

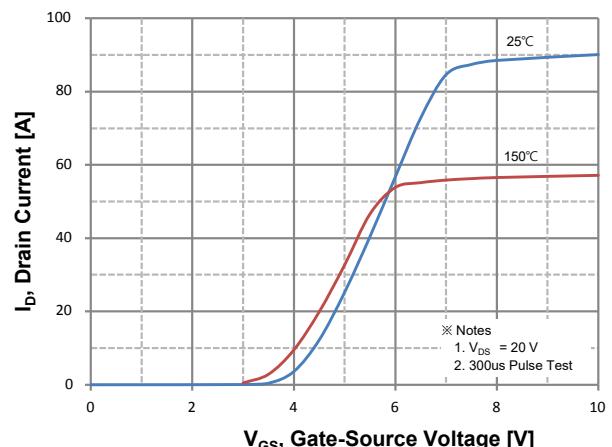


Figure 2. Transfer Characteristics

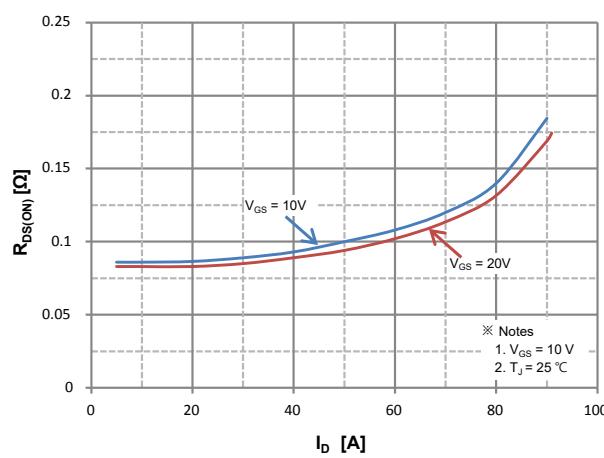


Figure 3. On Resistance Variation vs Drain Current and Gate Voltage

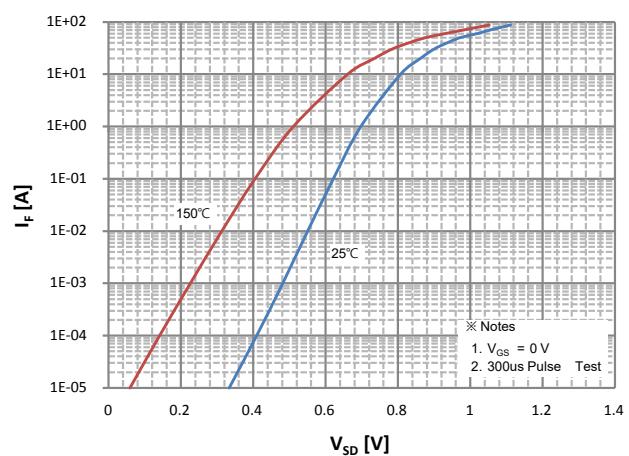


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

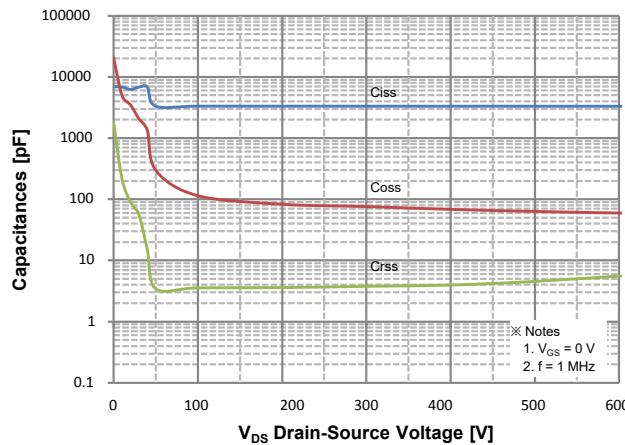


Figure 5. Capacitance Characteristics

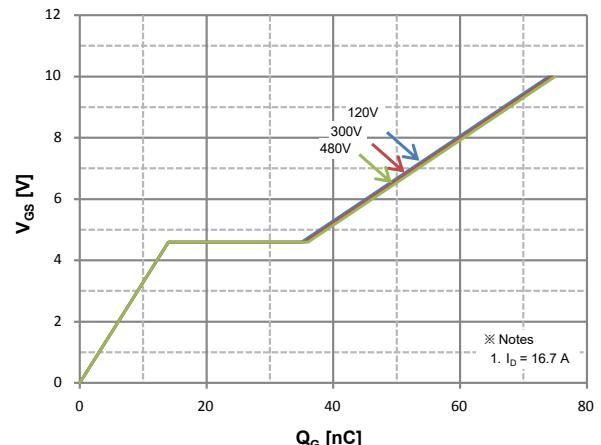
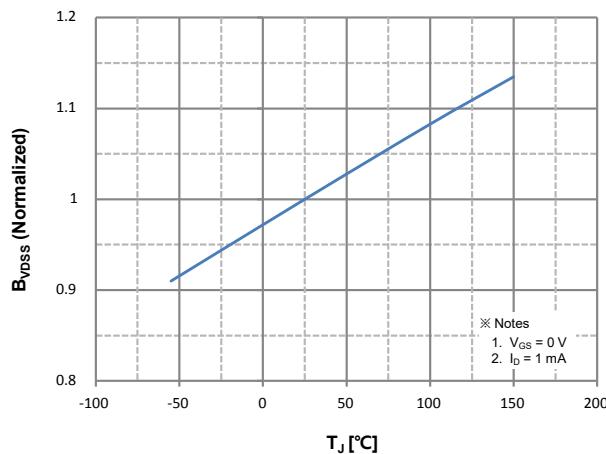
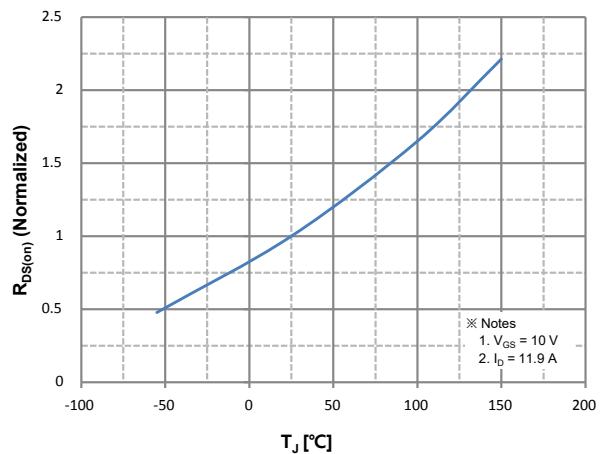


Figure 6. Gate Charge Characteristics

650V Super Junction Power MOSFET



**Figure 7. Breakdown Voltage Variation
vs. Temperature**



**Figure 8. On-Resistance Variation
vs. Temperature**

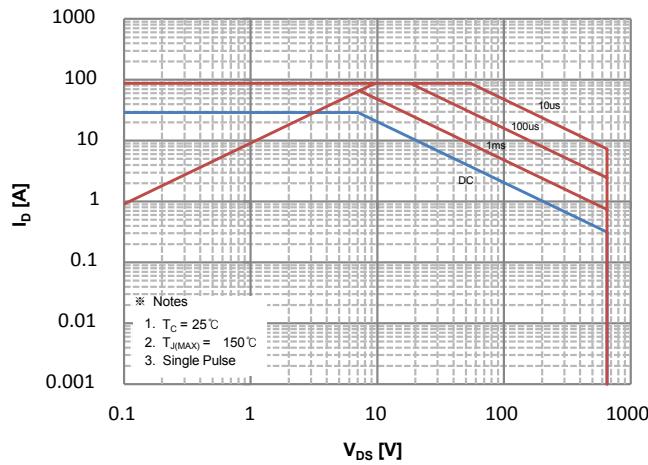
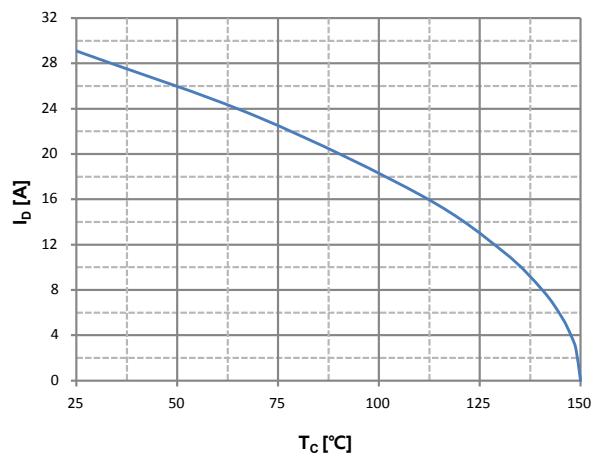


Figure 9. Maximum Safe Operating Area



**Figure 10. Maximum Drain Current
vs. Case Temperature**

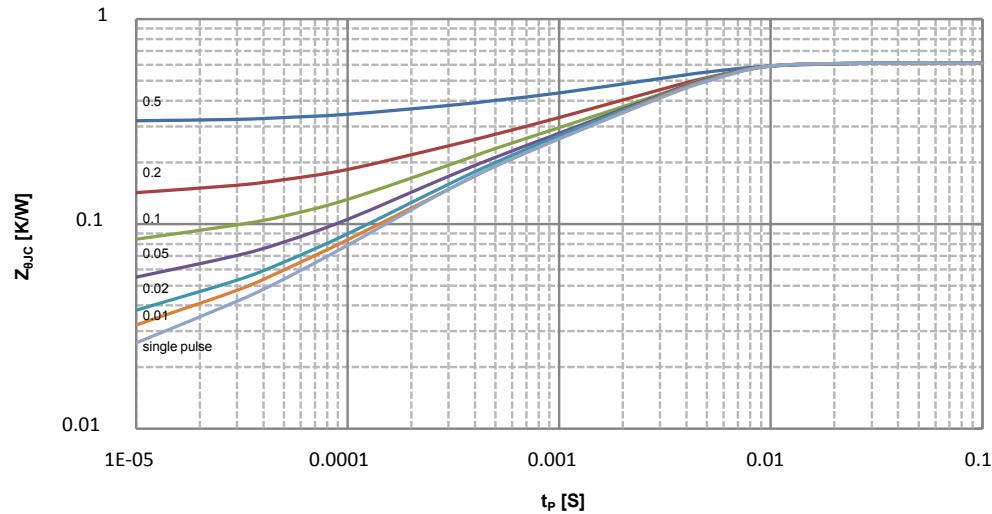
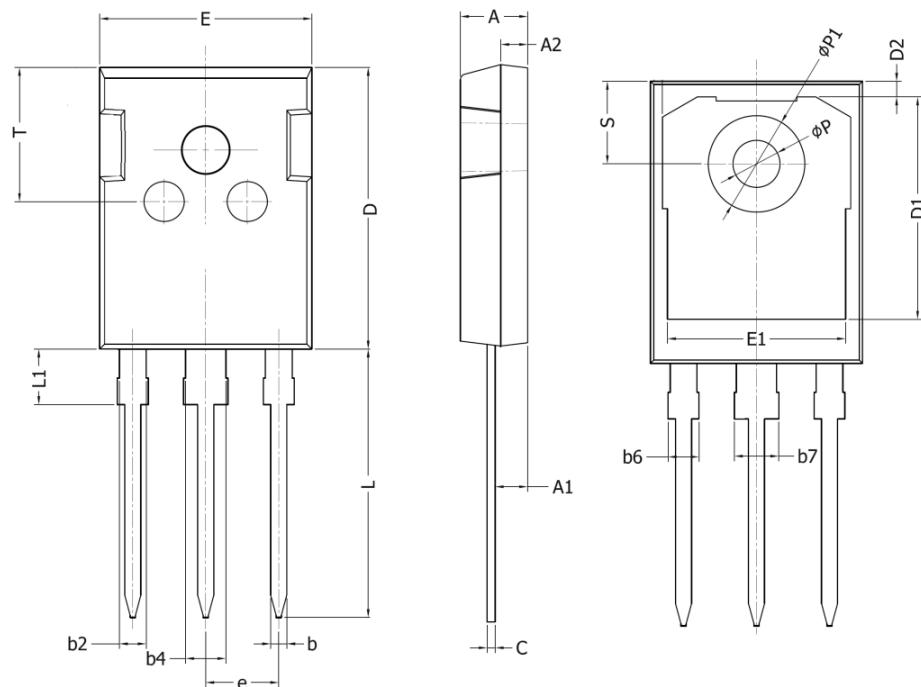


Figure 11. Transient Thermal Response Curve

650V Super Junction Power MOSFET

TO-247 Package Outline Dimensions



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	4.90	5.20
A1	2.31	2.51
A2	1.9	2.1
b	1.16	1.26
b2	1.96	2.06
b4	2.96	3.06
b6	-	2.25
b7	-	3.25
C	0.59	0.66
D	20.90	21.20
D1	16.25	16.85
D2	1.05	1.35
E	15.75	16.10
E1	13.00	13.60
e	5.436 BSC	
L	19.80	20.20
L1	-	4.30
P	3.40	3.60
P1	7.00	7.40
S	6.05	6.25
T	9.80	10.20